

Outline

Definition of Terms

Generic Measurement Setup

Transformer-Based Current Sensor

Bias Tee Pitfalls

Conclusions

Definition of Terms

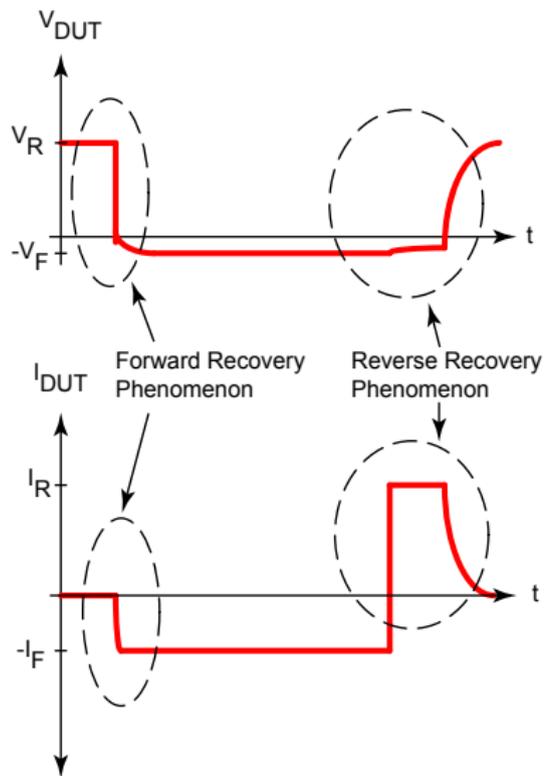
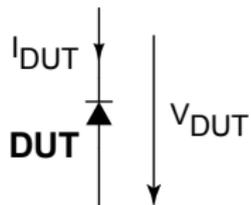
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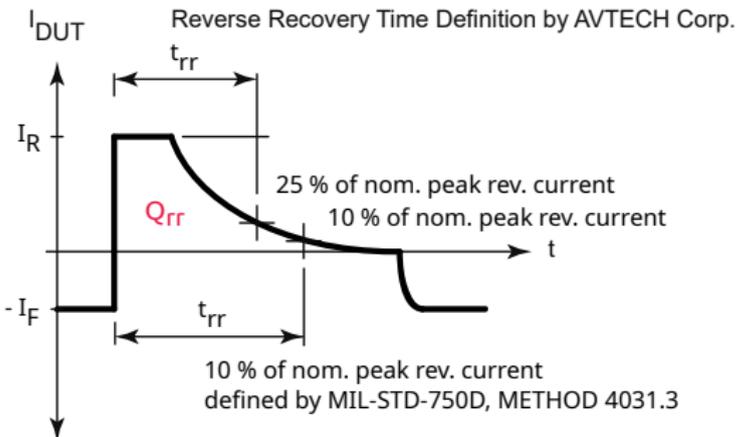
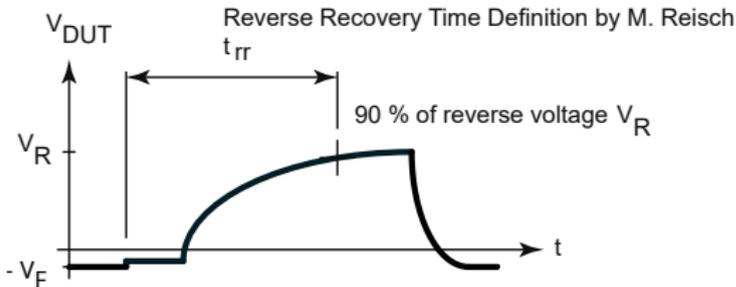
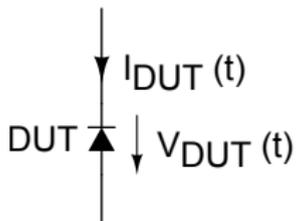
Conclusions

Charge Recovery Phenomenon of Diodes



Reverse Recovery Time of Diodes

Various Definitions



Reverse Recovery Time of Diodes

Various Definitions

Reverse Recovery Setup:

50 Ω and 100 Ω

Reverse Recovery Definition - I:

25 % of nominal peak reverse current [1]

Reverse Recovery Definition - II:

10 % of nominal peak reverse current [2]

MIL-STD-750D, method 4031.3

Reverse Recovery Definition - III:

90 % of reverse voltage [3]

Reverse Recovery Definition - IV:

Reverse recovered charge [4]

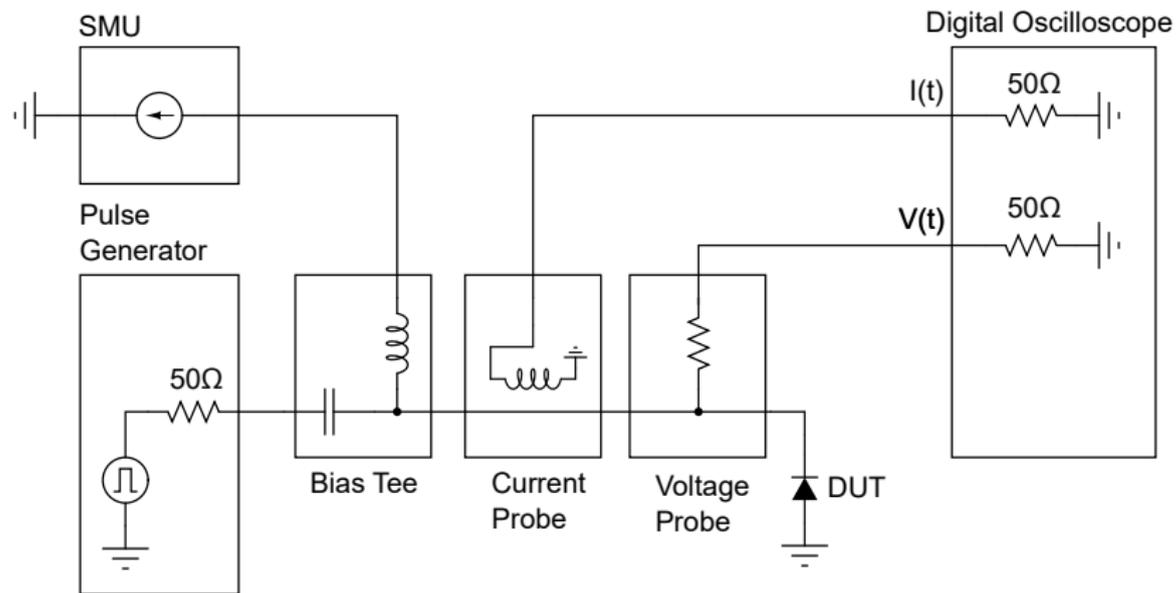
Definition of Terms

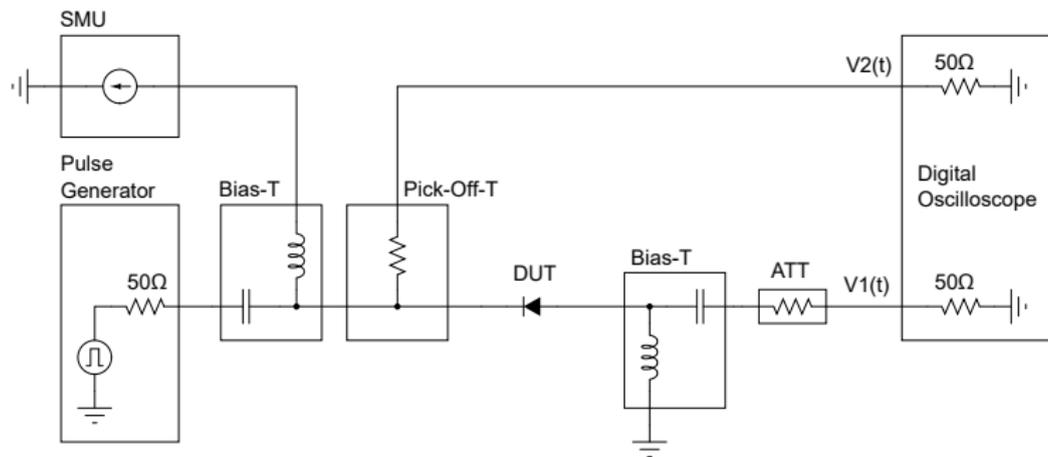
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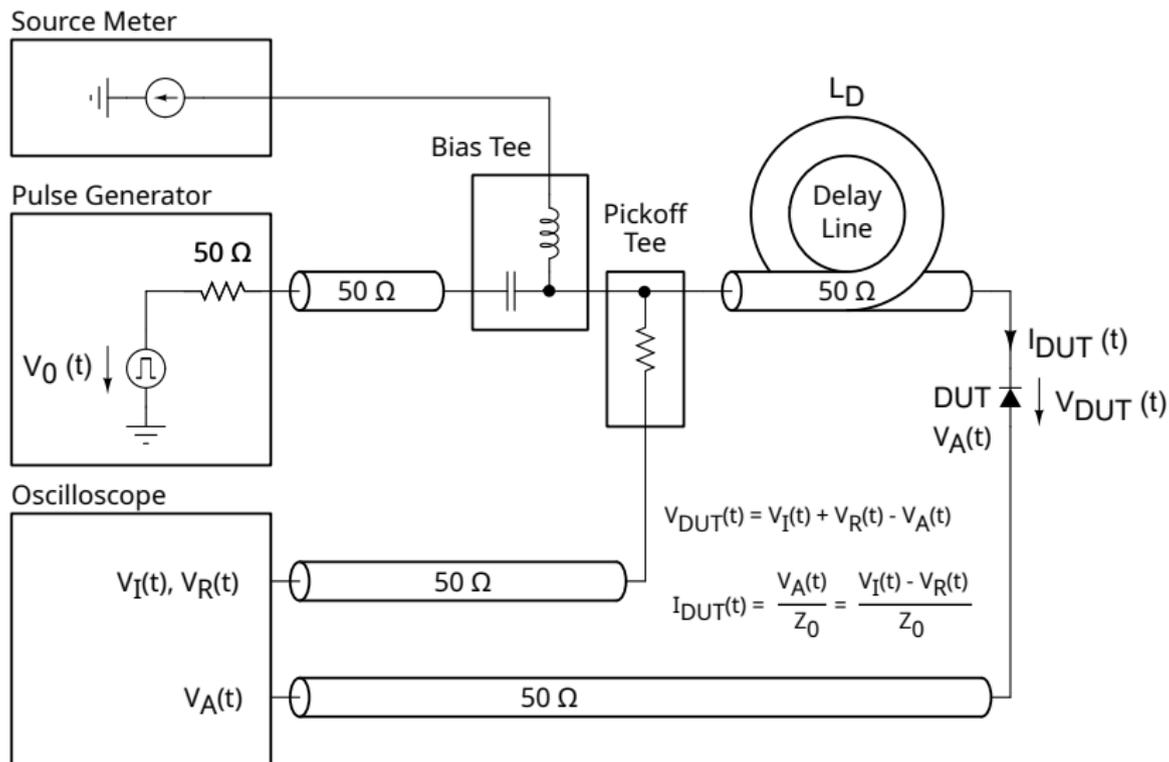


$$V_{DUT} = V2(t) \cdot k_{PT} - V1(t) \cdot k_{ATT}$$

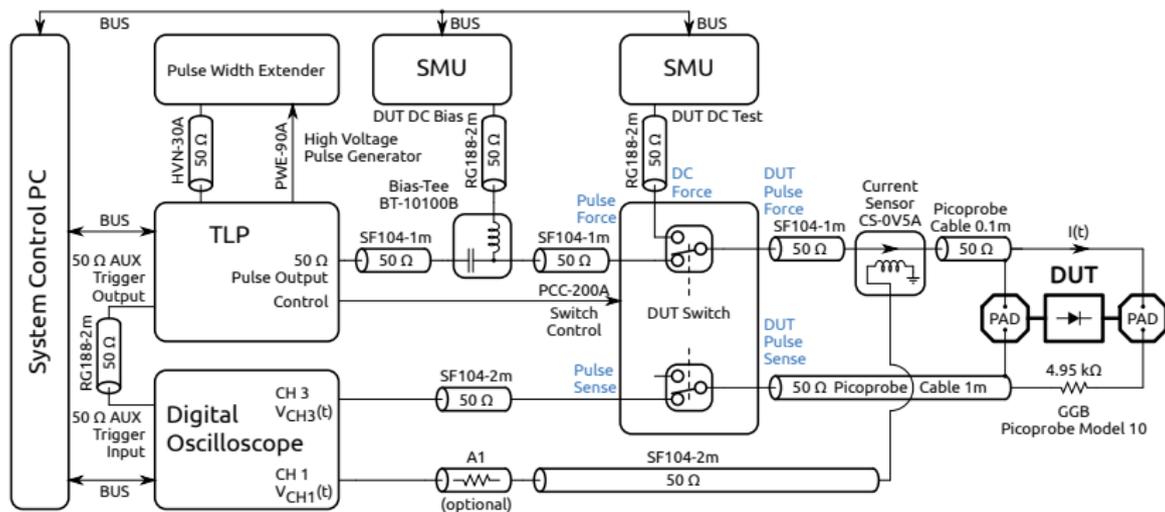
$$I_{DUT} = \frac{V1(t) \cdot k_{ATT}}{50 \Omega}$$

100 Ω TDR

Sub-ns Recovery Time Measurement



50 Ω Standard TLP



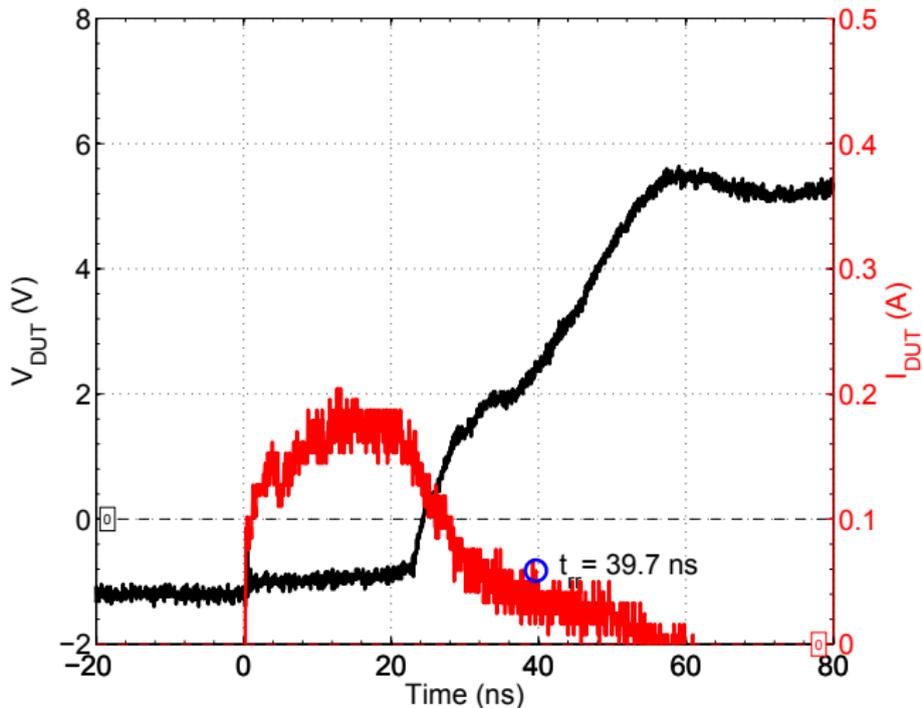
Reverse Recovery Time Measurement

t_{rr} Extraction Procedure (Example)

- ▶ Set the pulse parameters to minimum available rise time of 100 ps and a pulse width which is approximately two to three times the expected reverse recovery time.
- ▶ Operate diode in forward mode with a defined forward bias current I_F .
- ▶ Apply a reverse mode TLP pulse with a defined reverse voltage $V_R = V_{TLP} - |V_F|$. The pulse width of the TLP has to be increased until the voltage V_R remains steady state.
- ▶ Measurement of the nominal peak reverse current.
- ▶ Extract 25 % (or 10 % according MIL-STD) of the nominal peak reverse current.
- ▶ The time where the current I_{DUT} decreases down to 25 % (or 10 % according MIL-STD) of the nominal peak reverse current, is the reverse recovery time.

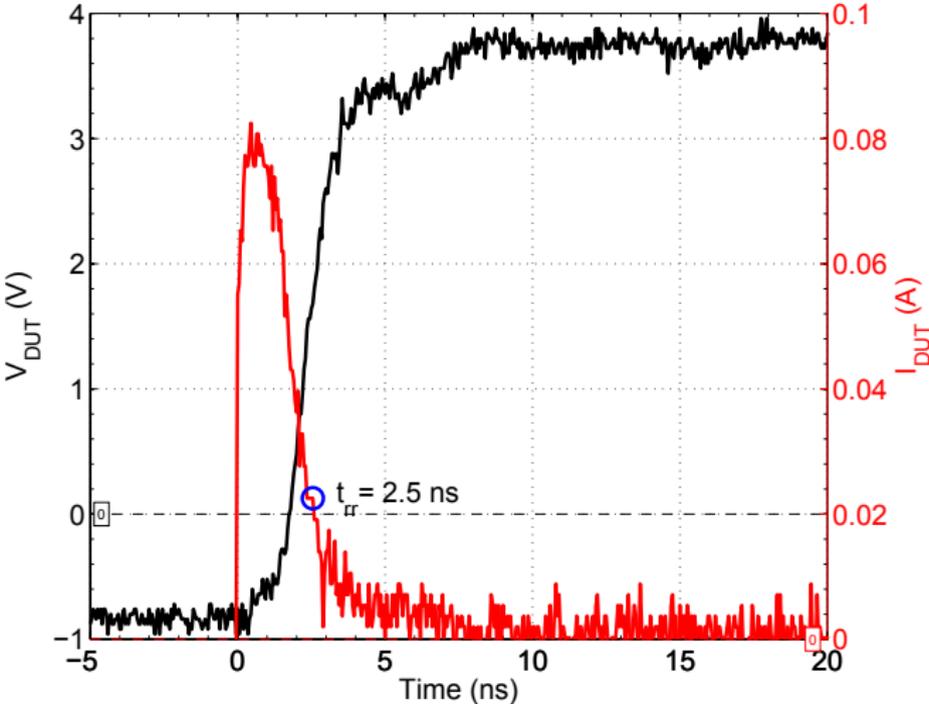
Reverse Recovery Transient Waveforms

Example: 39.7 ns



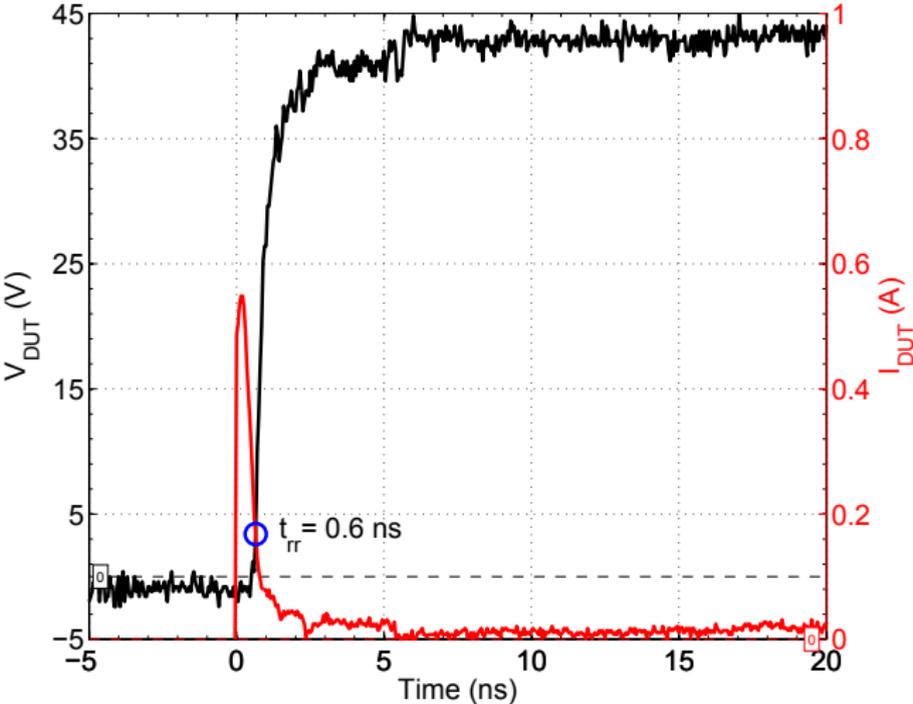
Reverse Recovery Transient Waveforms

Example: 2.5 ns



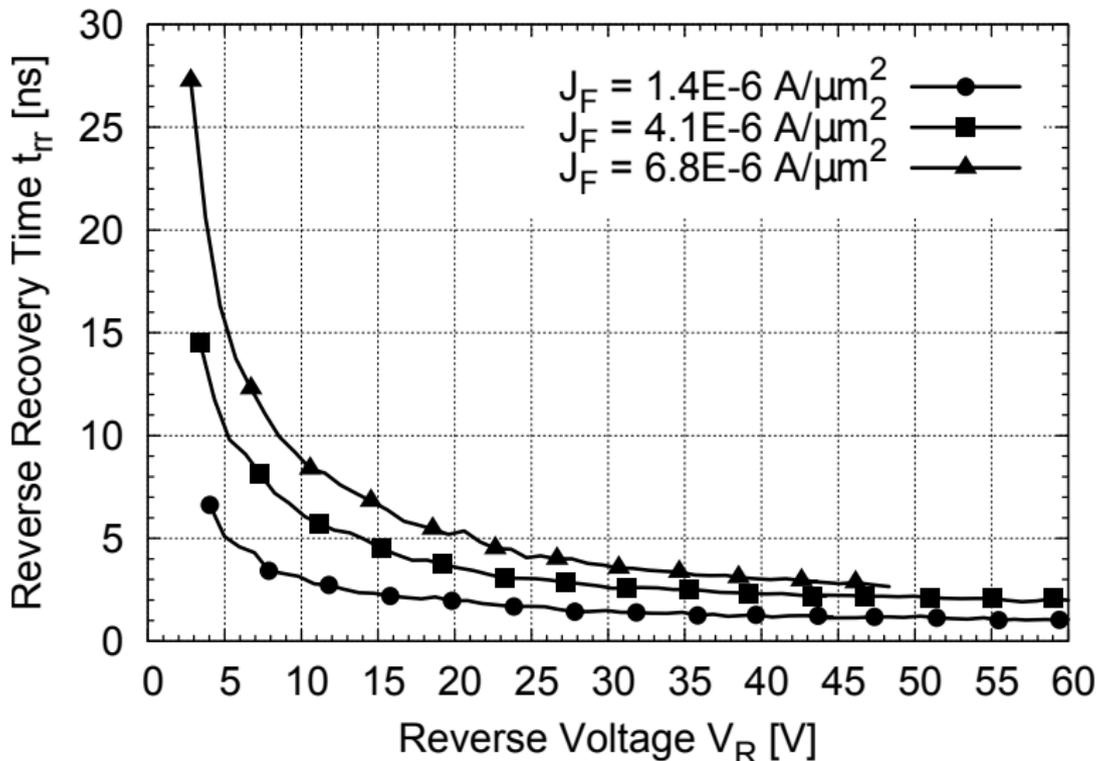
Reverse Recovery Transient Waveforms

Example: 0.6 ns



50 Ω Reverse Recovery Measurement Setup

Example: Reverse Recovery Measurement Result of a Silicon Diode



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- ▶ Transformer-based current sensors are widely used for TLP measurement because of its very low parasitic load impedance and high frequency bandwidth
- ▶ Drawback are zero DC current readout and potential magnetic core saturation
- ▶ Therefore the readout of the current sensor need to be corrected to obtain right results
- ▶ Magnetic core saturation must be avoided
- ▶ A SPICE equivalent model (no magnetic core saturation effects included) of a transformer-based current sensor (next slide) may help to review and analyze the situation

100 A, 3 GHz, 50 Ω , 0.5 V/A Current Sensor CS-0V5-A

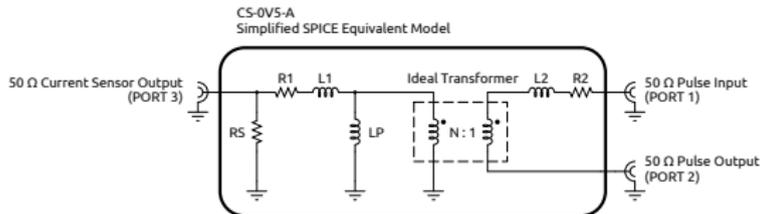
SPICE Equivalent Model

50 Ω Current Sensor Output
(PORT 3)



50 Ω Pulse Input
(PORT 1)

50 Ω Pulse Output
(PORT 2)



$$N = 18$$

$$k = 0.9999$$

$$R_S = 11 \Omega$$

$$R_1 = 0.1 \Omega$$

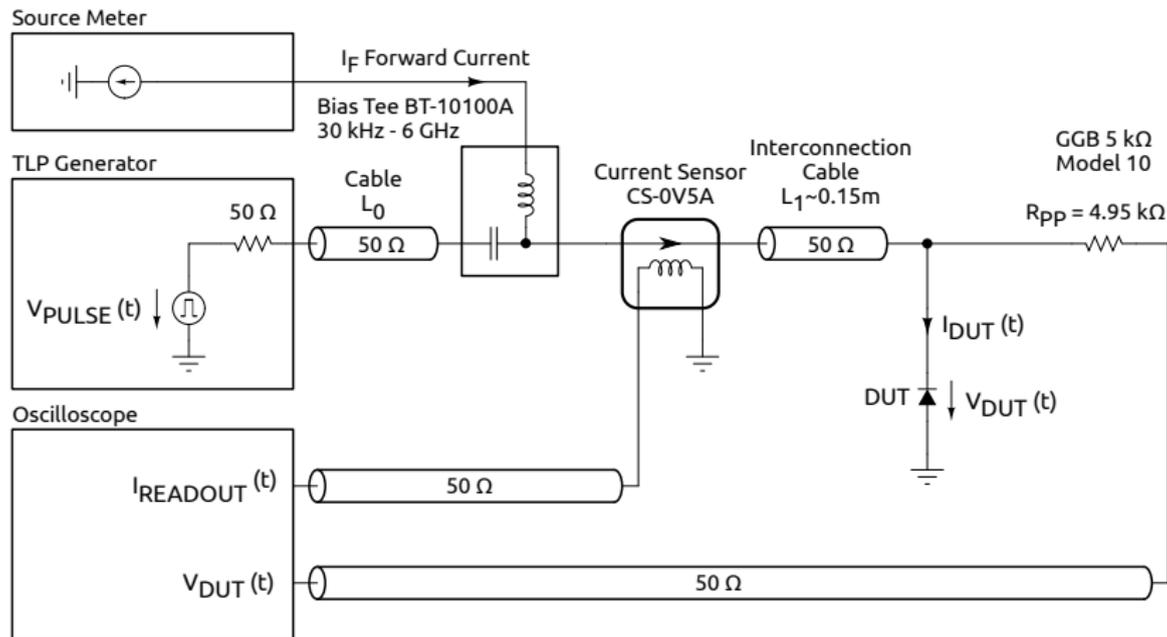
$$L_P = 1.324 \text{ mH}$$

$$L_1 = L_P \cdot \left(\frac{1}{k} - 1 \right) = 132.4 \text{ nH}$$

$$L_2 = \frac{L_1}{N^2} = 0.408 \text{ nH}$$

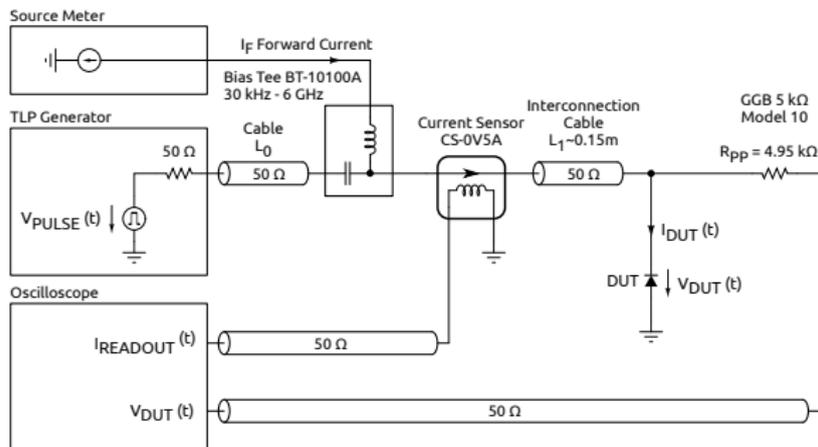
$$R_2 = 0.01 \Omega$$

Typical TLP Measurement Setup



- ▶ The transformer-based current sensor does not readout the DC bias current

Setup and Polarity Definition



- ▶ Voltage and current polarities are defined as shown in this schematic
- ▶ Therefore the diode forward current is considered as a negative value, e.g. $I_F = -45$ mA
- ▶ $I_{DUT,CALC} = I_{READOUT} + I_F$

Measurement Setup with Discrete Current Sensor

Transformer-based Current Sensor

- ▶ Because of the transformer, the current sensor will not read out the DC forward bias current I_F
- ▶ The sensor will read out the difference in the time domain:

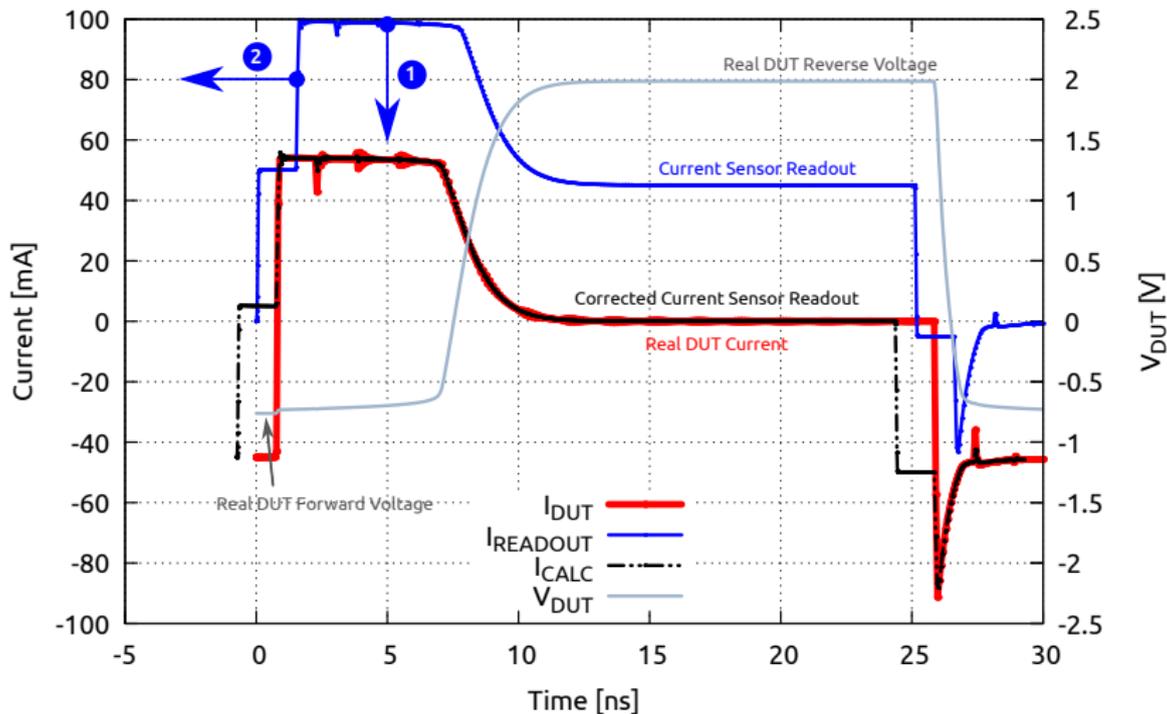
$$\text{Read Out Current} = I_{DUT} - I_F$$

- ▶ This means we need to correct the result by post processing to get the correct I_{DUT} value:

$$I_{DUT} = \text{Read Out Current} + I_F$$

- ▶ In addition the readout signals shows a delay and a plateau due to the cable L_1

How to Correct the Current Sensor Readout Signal?



How to Correct the Current Sensor Readout Signal?

Step 1: Shift down the current sensor readout signal by IF

Step 2: Shift left the current sensor readout signal by the delay time t_{L1} due to the cable length $L1$:

$$t_{L1} = \frac{L_1}{v} \approx \frac{L_1 \cdot \sqrt{\epsilon_r}}{c}$$

Example:

$$L_1 = 0.15 \text{ m}$$

$$v = 0.2 \text{ m ns}^{-1}$$

$$t_{L1} = 0.75 \text{ ns}$$

Probe Parasitics and Cable De-Embedding

Required to avoid wrong readouts

- ▶ Voltage scale factor of the 5k Picoprobe model 10:

$$\frac{4950 \Omega + 50 \Omega}{50 \Omega} = 100$$

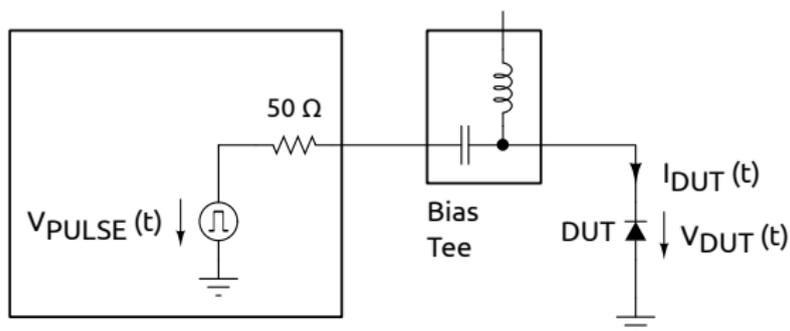
- ▶ Probe Parasitic Shunt Resistance:

$$4950 \Omega + 50 \Omega = 5000 \Omega$$

- ▶ Activate correct cable de-embedding
- ▶ **Disable** oscilloscope offset correction



Maximum Peak Reverse Current



- ▶ The maximum peak reverse current is **limited** by the pulse voltage:

$$I_{DUT,max} = \frac{V_{PULSE}}{50\ \Omega} + I_F$$

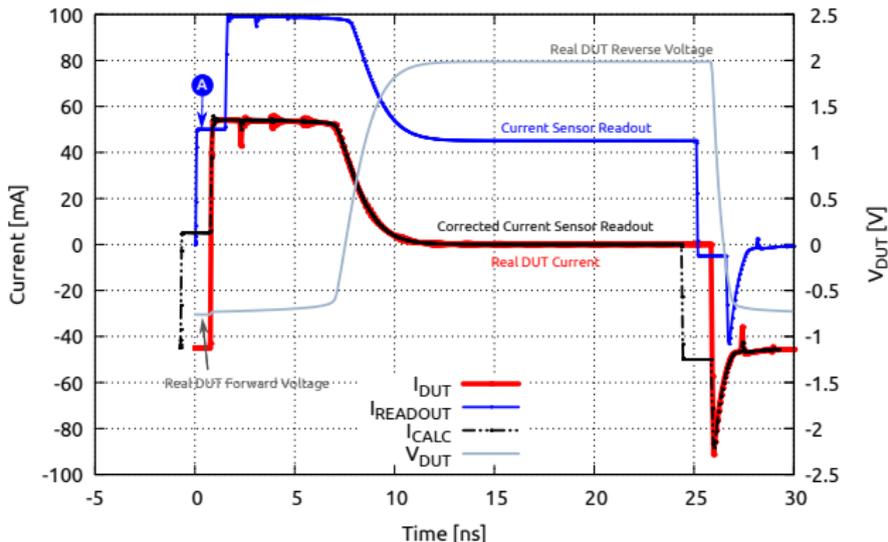
- ▶ Example:

$$V_{PULSE} = 5\ \text{V}, I_F = -45\ \text{mA}$$

$$\text{Maximum possible peak reverse current: } I_{DUT,max} = 55\ \text{mA}$$

Readout Detail A

$V_{PULSE} = 5V, I_F = -45\text{ mA}$

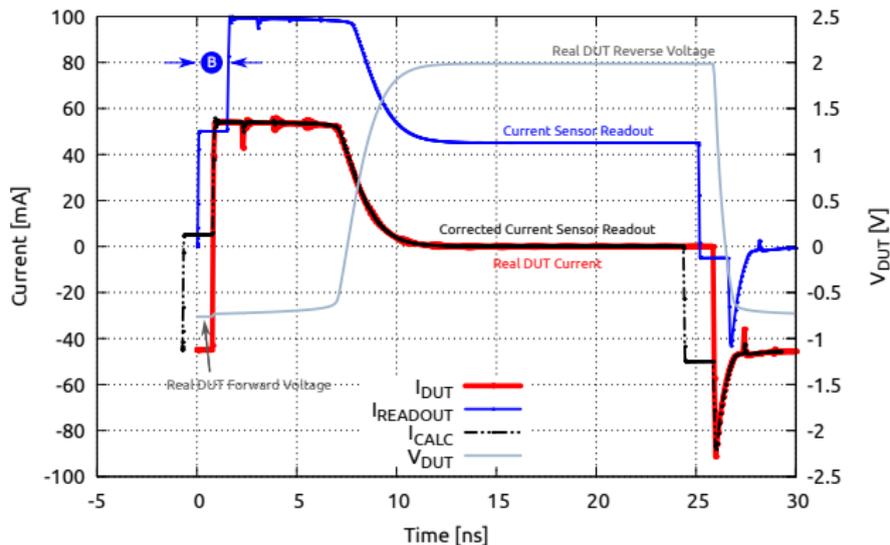


- ▶ The amplitude of the plateau **A** results from:

$$I_A = \frac{V_{PULSE}}{2} \cdot \frac{1}{50\Omega} = 50\text{ mA}$$

Readout Detail B

$V_{PULSE} = 5V, I_F = -45mA$

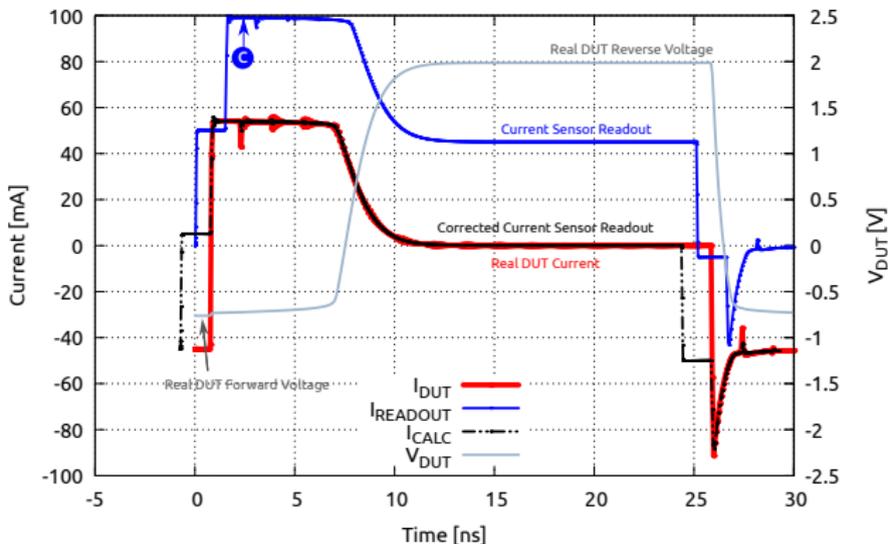


- ▶ The pulse width **B** of plateau **A** (page 27) results from:

$$t_B = 2 \cdot t_{L1} = \frac{2 \cdot L_1}{V} \approx \frac{2 \cdot L_1 \cdot \sqrt{\epsilon_r}}{C}$$

Readout Detail C

$V_{PULSE} = 5V, I_F = -45\text{ mA}$



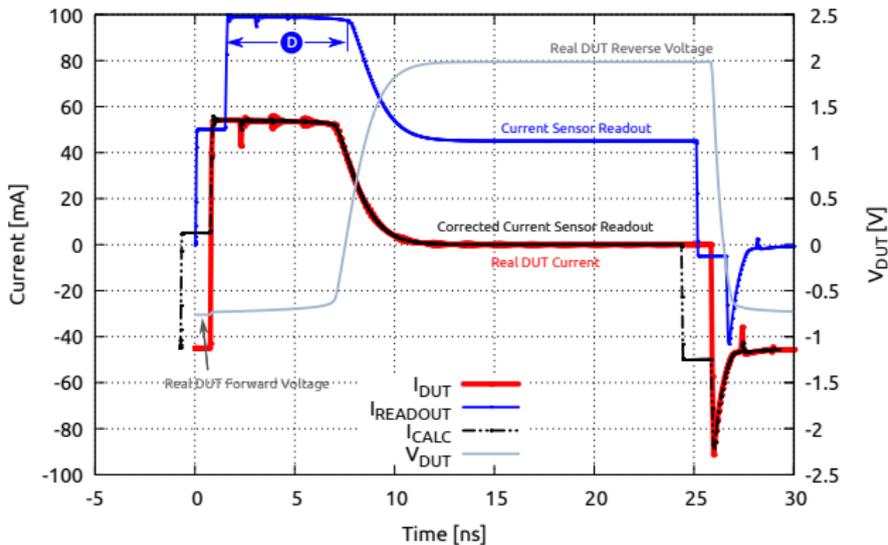
- ▶ The amplitude of the plateau **C** results from:

$$I_{C,max} = V_{PULSE} \cdot \frac{1}{50\Omega} = 100\text{ mA}$$

- ▶ The peak value can be less in case Q_{rr} is small, but never $> I_{C,max}$

Readout Detail D

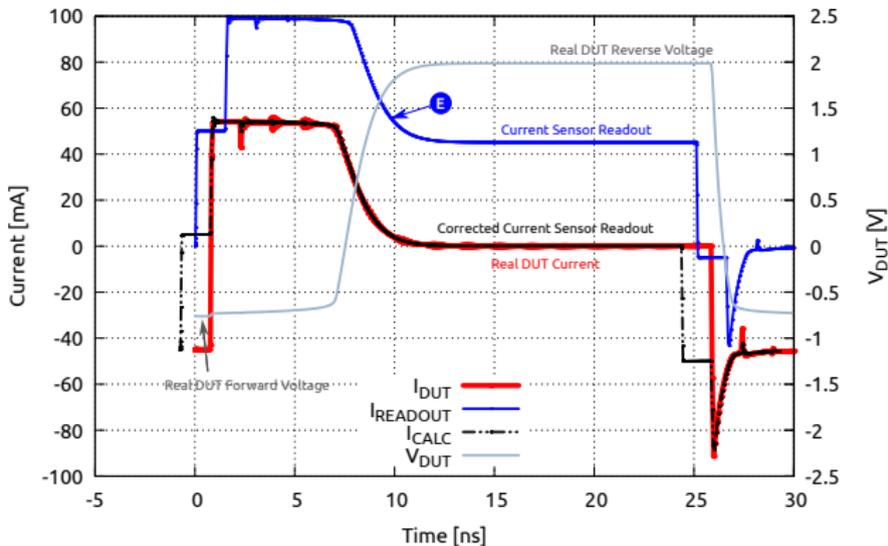
$$V_{PULSE} = 5V, I_F = -45\text{ mA}$$



- ▶ The time **D** is depending on Q_{rr}

Readout Detail E

$V_{PULSE} = 5V, I_F = -45\text{ mA}$



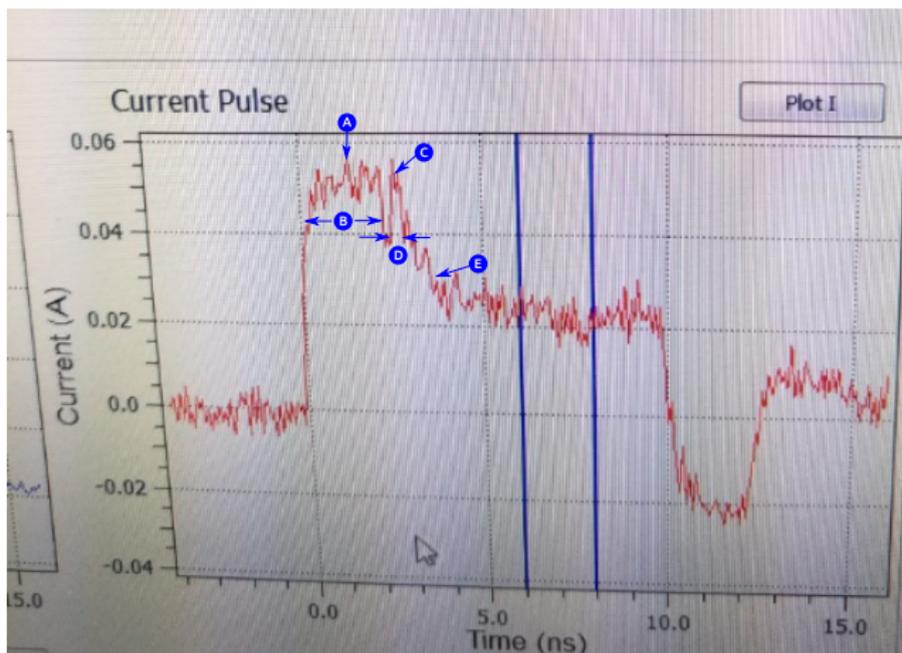
- ▶ The decay **E** is depending on C_{j0}

Calculation of the DUT Current

Using Transformer-based Current Sensors

- ▶ Post-processing procedure:
 1. Shift left $I_{READOUT}$ by $t_B/2$ on the time axis
 2. Add DC bias current: $I_{DUT,CALC} = I_{READOUT} + I_F$
- ▶ $I_{DUT,CALC}$ is valid after t_B , this means that the time t_B needs to be blanked (set $I_{DUT,CALC} = I_F$) in order to get the right peak reverse current of the diode.
- ▶ Precise evaluation of t_B is necessary for this purpose
- ▶ In all cases for I_F and V_{PULSE} the calculated peak reverse current and decay give the right result, despite the current sensor delay

Example With Very Low Q_{rr}



- ▶ All details **A-E** as described before

Definition of Terms

Generic Measurement Setup

Transformer-Based Current Sensor

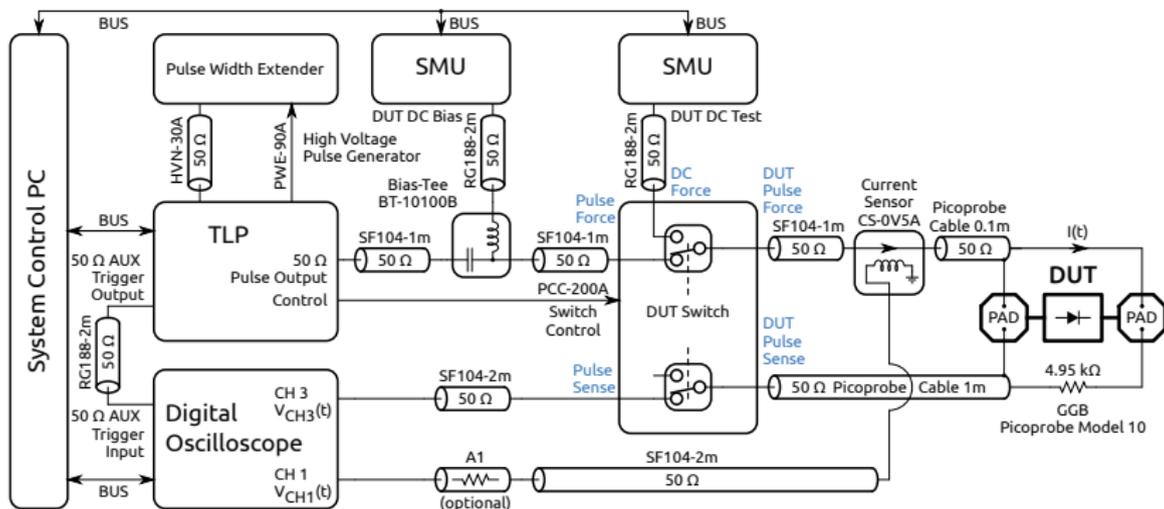
Bias Tee Pitfalls

Conclusions

- ▶ Bias tee's are widely used for TLP and charge recovery measurements
- ▶ Despite of the advantages of using bias tee's, there are two major drawbacks:
 1. Potential SMU control loop instabilities and oscillations
 2. Potential DUT voltage and current transient distortions
- ▶ There are two options:
 1. Don't use bias tee's (= separate topic for presentation)
 2. Use bias tee's and review/analyze the risk of malfunction

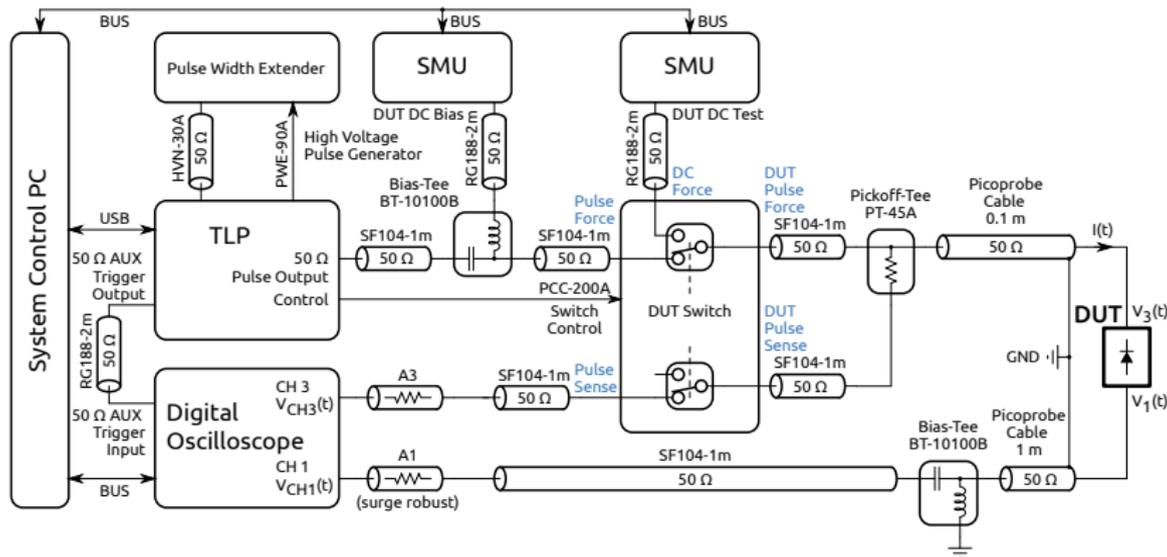
Example: 50 Ω Measurement Setup

Single Bias Tee



Example: 100 Ω Measurement Setup

Dual Bias Tee



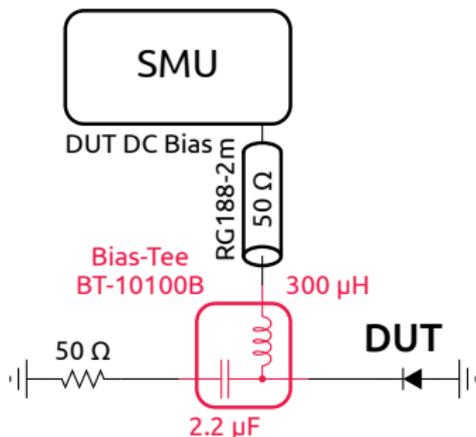
There are a lot of RF bias tees on the market, but it is probably very hard to find the unique combination of features required for TLP:

- ▶ High voltage capability
- ▶ Low cut-off frequency 30 kHz (for large μs pulse width)
- ▶ High cut-off frequency >7 GHz (for VF-TLP)
- ▶ Low insertion loss (for low pulse distortion)
- ▶ Low reflection coefficients (for low pulse distortion)

Therefore HPPI did develop bias tees suitable for TLP to combine all features mentioned above.

Bias Tee Pitfall #1: SMU Control Loop Instabilities

Can Cause High Voltage SMU Oscillation and SMU/DUT Damage



- ▶ For typical TLP measurements the 50 Ω bias tee must have a low cut-off frequency of around 30 kHz for large pulse width and an upper cut-off frequency in the range of 7 GHz to ensure a fast pulse rise time. This results in quite large L and C values inside the bias tee.

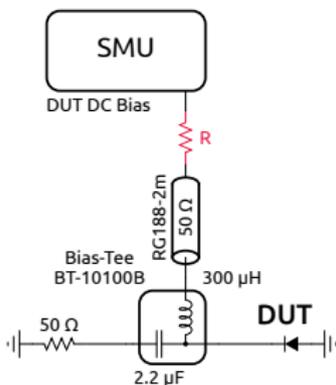
Bias Tee Pitfall #1: SMU Control Loop Instabilities

Can Cause High Voltage SMU Oscillation and SMU/DUT Damage

- ▶ This extreme load impedance at the SMU output may have strong impact on the control loop of the SMU. Depending on the phase margin of the SMU open-loop gain, the SMU output may become unstable. Unexpected damage of the DUT may happen because of a sudden SMU output runaway or high voltage oscillations. If the DUT impedance is changing in a wide range from short circuit to high impedance or representing a nonlinear characteristic, the SMU stability will be dependent on the DUT impedance in the measurement setup. Note: the situation may change significantly in case of a 4-wire (Kelvin) setup.
- ▶ Investigate the stability of the SMU with a separate test setup, check the SMU manual and/or contact the SMU vendor

Bias Tee Pitfall #1: SMU Control Loop Instabilities

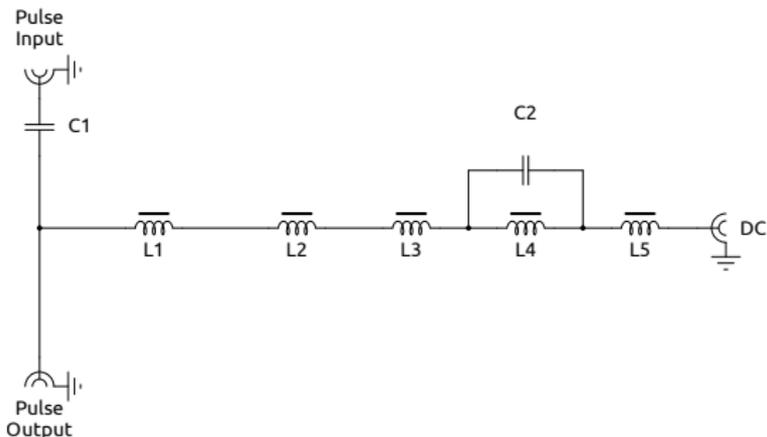
Countermeasure



- ▶ A simple but very effective countermeasure to increase the SMU control loop stability is to connect a resistor R directly at the output of the SMU.
- ▶ The value of the resistor should be as large as possible. Several hundred Ω to $\text{k}\Omega$ may be sufficient.

Bias Tee Pitfall #2: Dynamic Transient Distortions

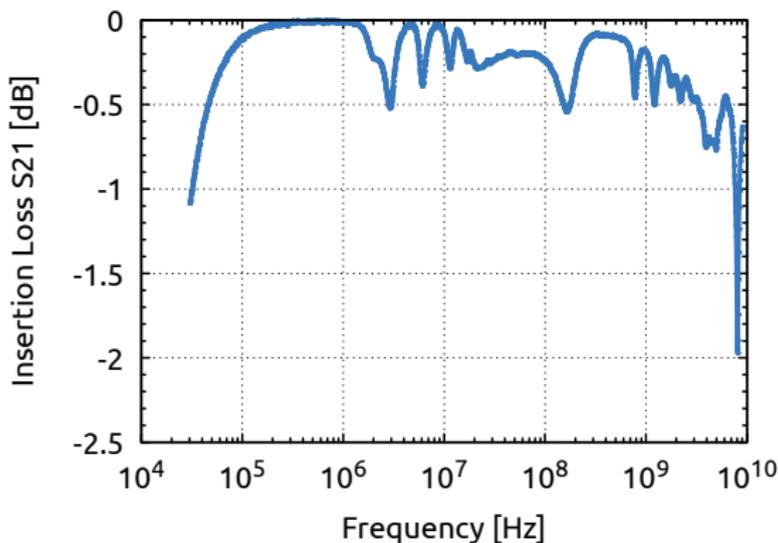
Root Cause



- ▶ By its nature, a bias-tee represents a multi-resonant wide-band circuit

Bias Tee Pitfall #2: Dynamic Transient Distortions

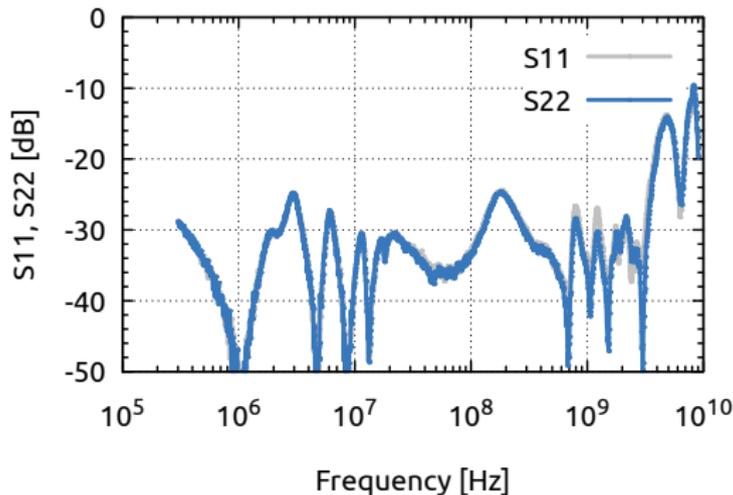
Bias Tee Typical Characteristics



- ▶ BT-10100B (<https://www.hppei.de/files/BT10100B.pdf>) pulse input to output transfer characteristic

Bias Tee Pitfall #2: Dynamic Transient Distortions

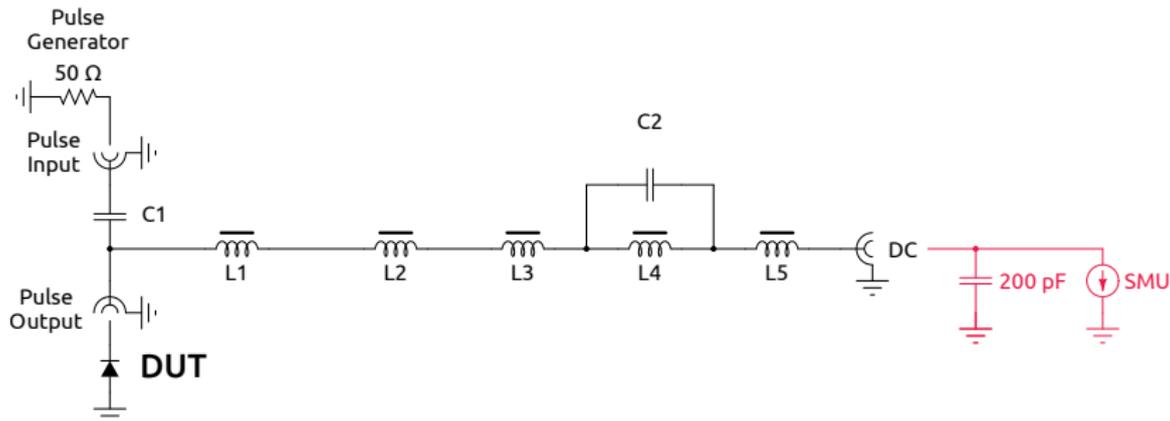
Bias Tee Typical Characteristics



- ▶ BT-10100B (<https://www.hppi.de/files/BT10100B.pdf>) pulse input/output return loss

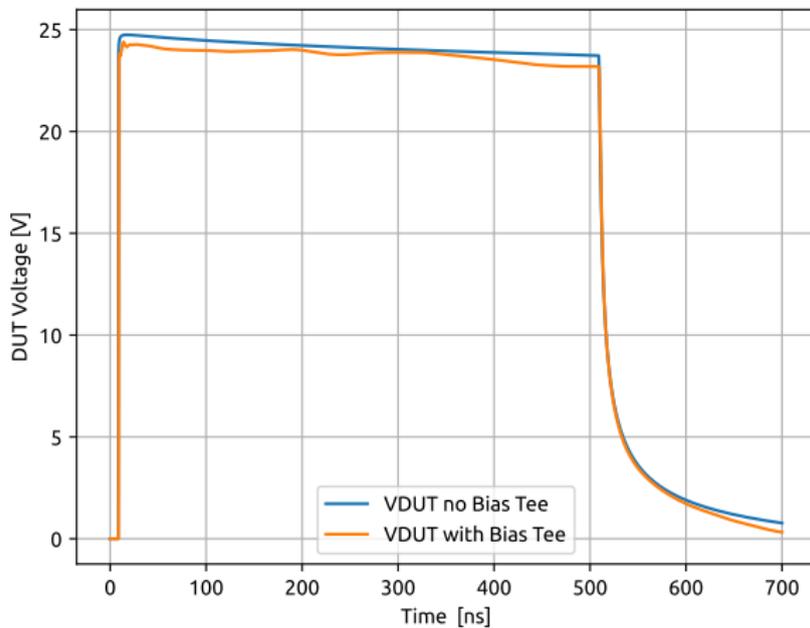
Bias Tee Pitfall #2: Dynamic Transient Distortions

Root Cause



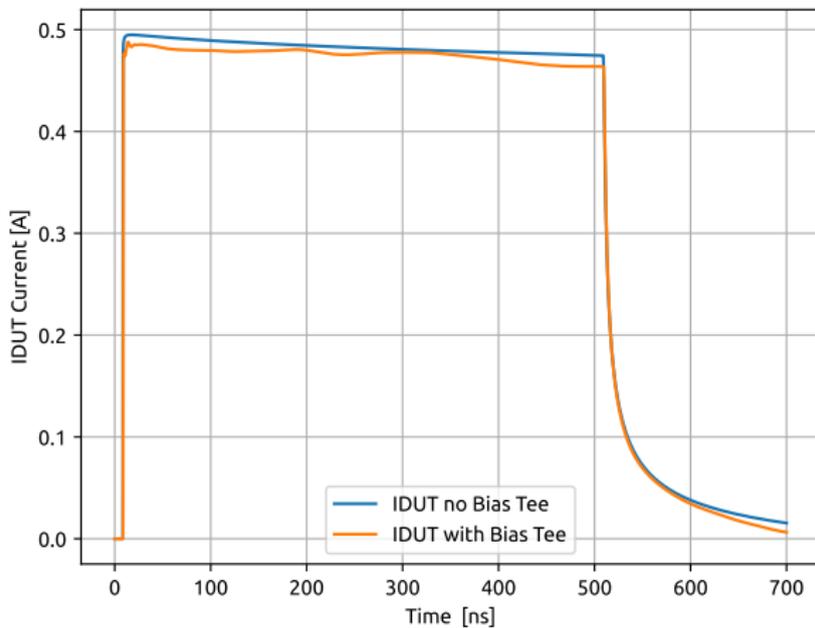
- ▶ $200\ \text{pF}$ is the equivalent capacitance of 2 m long $50\ \Omega$ cable
- ▶ Root cause: pulse excitation of a multi-resonant circuit at very low resonant frequency

Bias Tee Pitfall #2: Dynamic Transient Distortions



► VDUT distortion

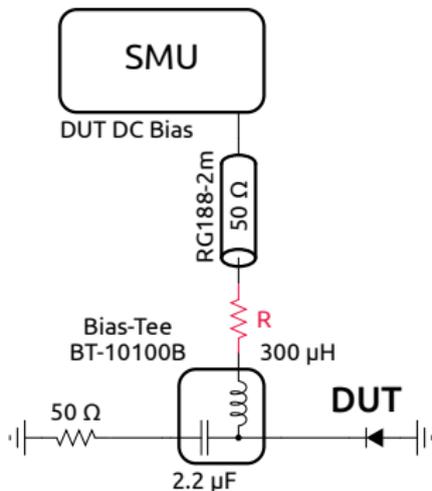
Bias Tee Pitfall #2: Dynamic Transient Distortions



► IDUT distortion

Bias Tee Pitfall #2: Dynamic Transient Distortions

Countermeasure



- ▶ Connect series resistor to isolate the parasitic cable capacitance
- ▶ Required for SMU in current force mode
- ▶ Not required for SMU in voltage force mode

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Bias Tee Pitfalls

Conclusions

- ▶ Charge recovery measurements require exact specification and documentation of test method, measurement setup and extraction procedure. Otherwise the measured numbers are useless.
- ▶ Transformer-based current sensors require special readout data processing
- ▶ The impact of bias tee's in the setup need to be investigated in detail
- ▶ Extraction of Q_{rr} can be easily done by post processing (not covered in this presentation)
- ▶ HPPI support with Python code snippets for effective data processing

- [1] AVTECH Electrosystems LTD, “A comparison of reverse recovery measurement systems,” Nov. 2006.
- [2] *MIL-STD-750D, method 4031.3, reverse recovery characteristics,*
- [3] M. Reisch, *Elektronische Baulemente*, 2nd ed. Springer, 2007, ISBN: 3-540-34014-9.
- [4] N. Shammass, D. Chamund, and P. Taylor, “Forward and reverse recovery behaviour of diodes in power converter applications,” in *Microelectronics, 2004. 24th International Conference on*, vol. 1, May 2004, pp. 3–10.